

Description

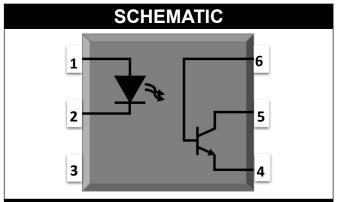
The CNY17-X, CNY17F-X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP6 package with different lead forming options.

Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL CSA Component Acceptance
 Service Notice No. 5A

Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



PIN DEFINITION

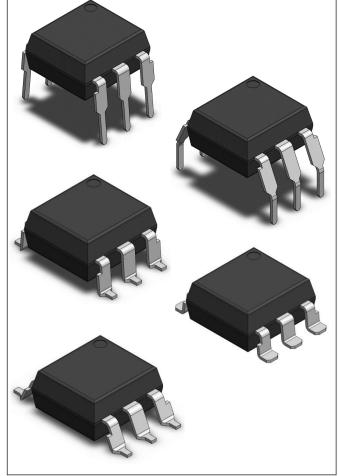
1.Anode 6.Base(CNY17)

2.Cathode or NC(CNY17-F)

3.NC 5.Collector

4.Emitter

PACKAGE OUTLINE







CNY17-X, CNY17F-X Series DIP6, DC Input, Photo Transistor Coupler

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	I _F	60	mA				
Peak Forward Current	I _{FP}	1	Α	1			
Reverse Voltage	V _R	6	V				
Input Power Dissipation	Pı	100	mW				
OUTPUT							
Collector - Emitter Voltage	V _{CEO}	80	V				
Emitter - Collector Voltage	V _{ECO}	7	V				
Collector Current	Ic	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	250	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~150	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100μs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$





	ELECTR	ICAL OP	TICAL	_ CHA	RAC	TERI	STICS at Ta=25°C	
PARAM	1ETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
				INP	UT			
Forward	Voltage	V _F	-	1.24	1.4	V	IF=10mA	
Reverse	Current	I _R	-	-	10	μA	VR=6V	
Input Cap	acitance	Cin	-	10	-	pF	V=0, f=1kHz	
OUTPUT								
Collector Da	ark Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0	
Collector Breakdow		BV _{CEO}	80	_	-	V	IC=0.1mA, IF=0	
Emitter-C Breakdow		BV _{ECO}	7	-	-	V	IE=0.1mA, IF=0	
		TR	ANSFE	R CHA	RACT	ERIS	TICS	•
	CNY17-1 CNY17F-1		40	-	80			
Current	CNY17-2 CNY17F-2	CTR	63	-	125			
Transfer Ratio	CNY17-3 CNY17F-3		100	-	200	%	IF=10mA, VCE=5V	
	CNY17-4 CNY17F-4		160	-	320			
	CNY17-1 CNY17F-1		13	-	-			
Current Transfer Ratio	CNY17-2 CNY17F-2	CTD	22	-	-	0/		
	CNY17-3 CNY17F-3	CTR	34	-	-	%	IF=1mA, VCE=5V	
	CNY17-4 CNY17F-4		56	-	-			
Collector Saturation		V _{CE(sat)}	-	-	0.3	V	IF=10mA, IC=2.5mA	
Isolation R	esistance	Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Ca	pacitance	C _{IO}	-	0.5	1	pF	V=0, f=1MHz	





ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
TRANSFER CHARACTERISTICS							
Turn-on Time	ton	_	10	12			
Turn-off Time	toff	-	9	12		VCC=10V, IC=2mA	
Response Time (Rise)	tr	-	6	10		RL=100Ω	
Response Time (Fall)	tf	-	8	10	μs		
Response Time (Rise)	tr	-	2	10		VCC=5V, IF=10mA	
Response Time (Fall)	tf	-	3	10		RL=75Ω	

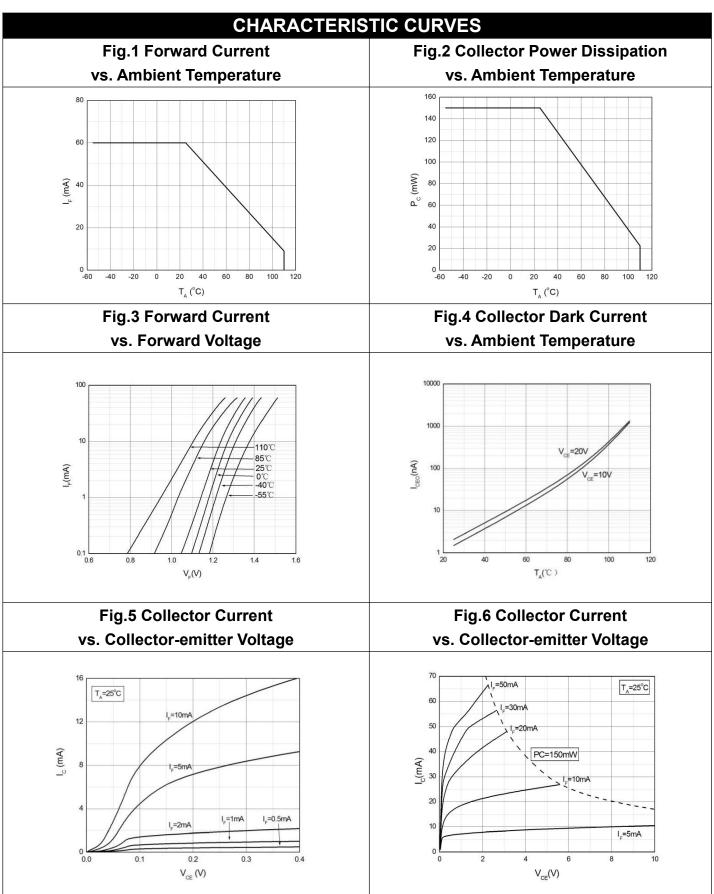
TEST CIRCUITS					
Test Circuits of Response Time	Curves of Response Time				
V _{CC} I _c R _L Output Sense	Input Pulse Output Pulse 10% tr — tf ton — toff				



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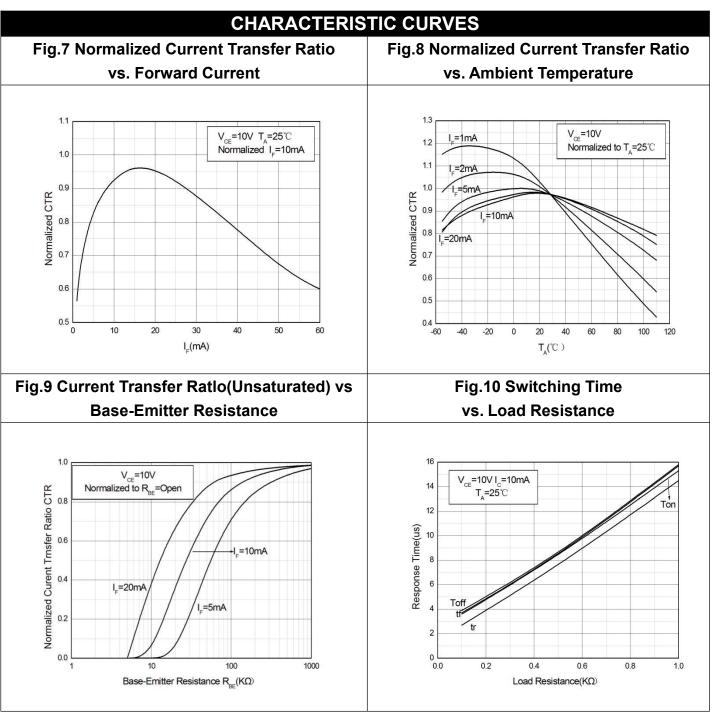
DIP6, DC Input, Photo Transistor Coupler

Release Date: 2024/08/19



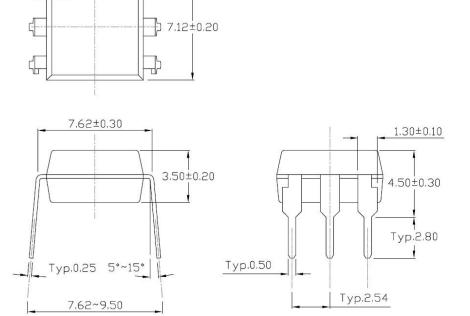
Rev: A00



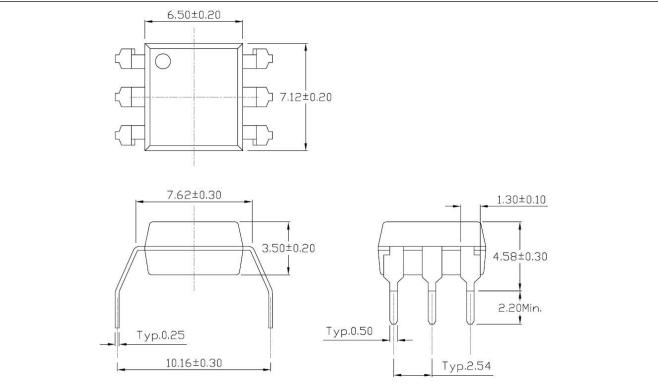




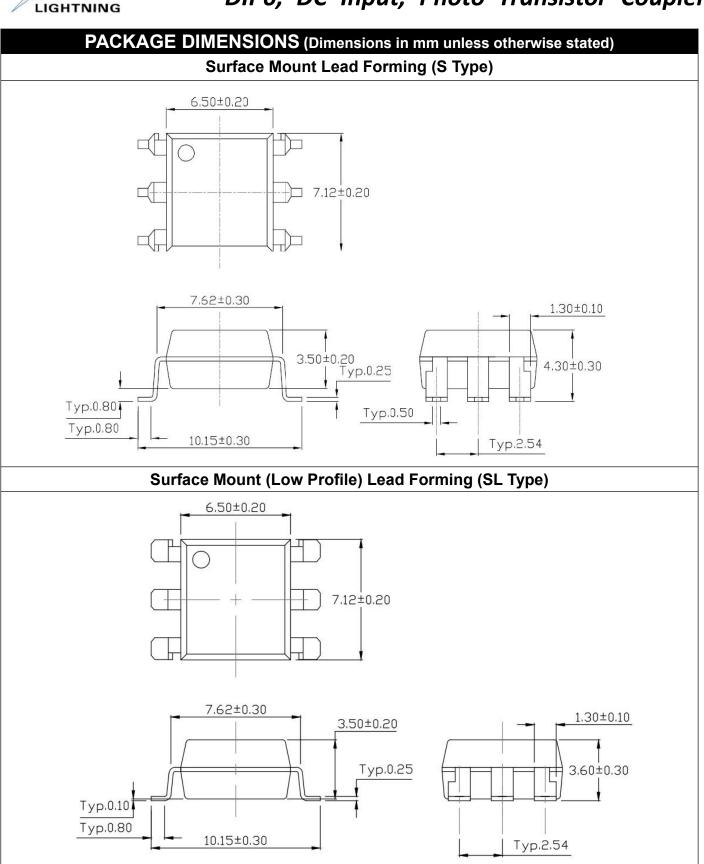
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Standard DIP - Through Hole (DIP Type) 6.50±0.20



Gullwing (400mil) Lead Forming – Through Hole (M Type)

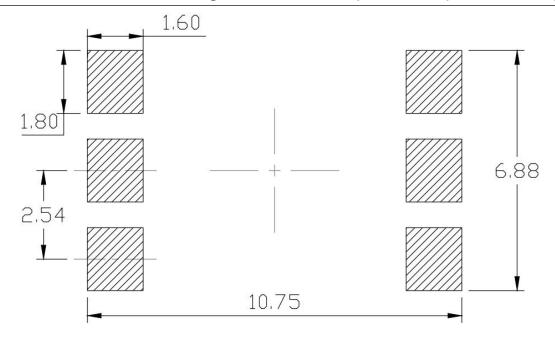




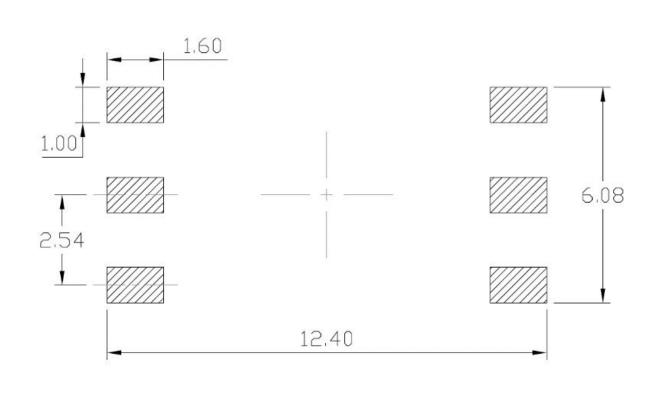




Recommended Solder Mask (Dimensions in mm unless otherwise stated) Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

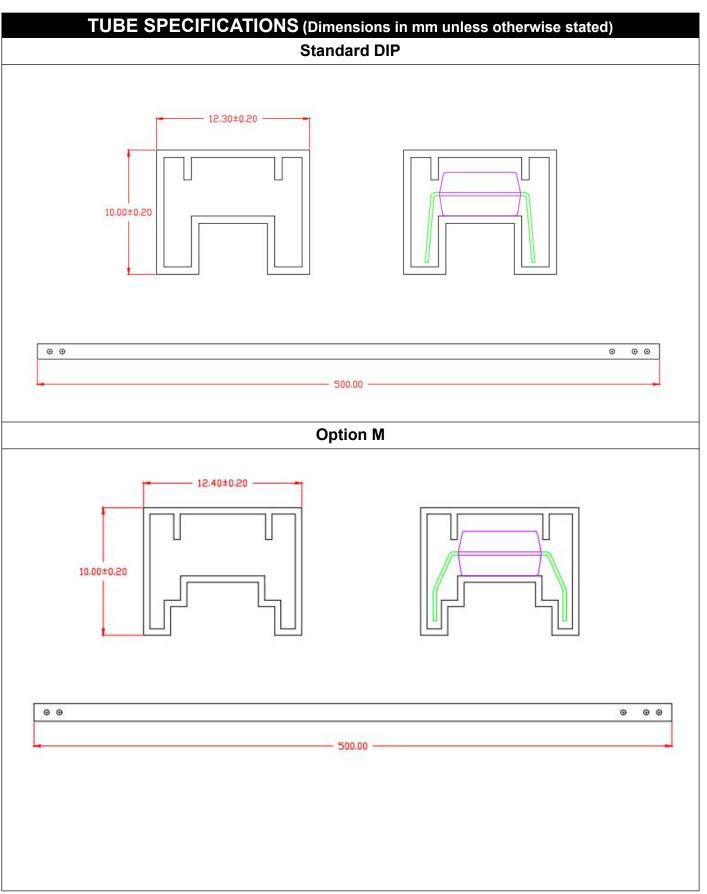


Surface Mount (Gullwing) Lead Forming



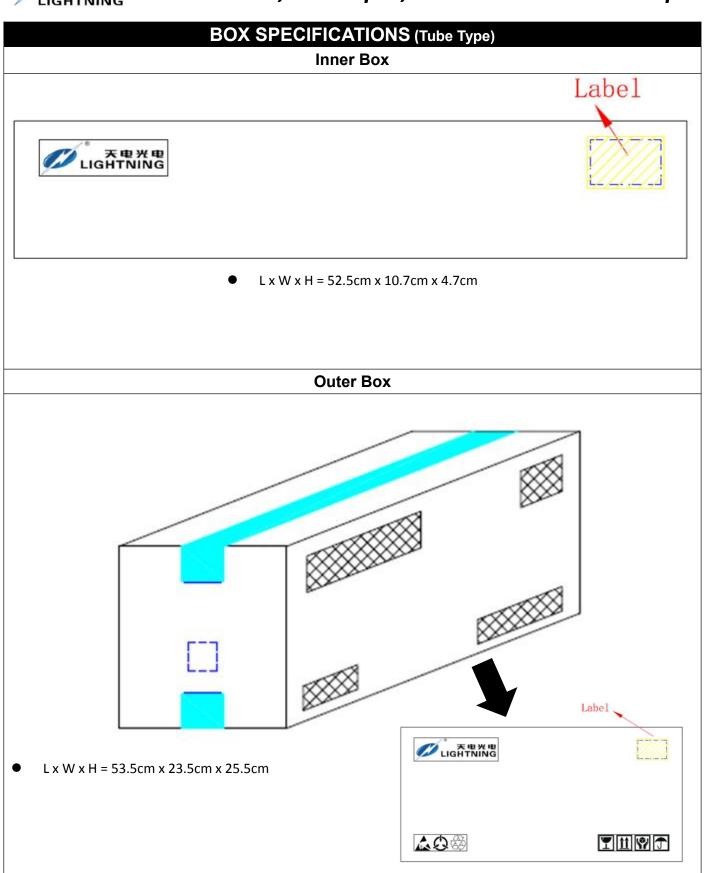


www.tdled.com CNY17-X, CNY17F-X Series DIP6, DC Input, Photo Transistor Coupler













Carrier Tape Specifications (Dimensions in mm unless otherwise stated) **Option S(T1)** 4.00 - 1-2.00- Ø1,50 -1.757,50 16.00 -4,50 -12.00 Option S(T2) 4.00 --2.00 Ø1,50 -1.757,50 16.00 4,50 -12.00



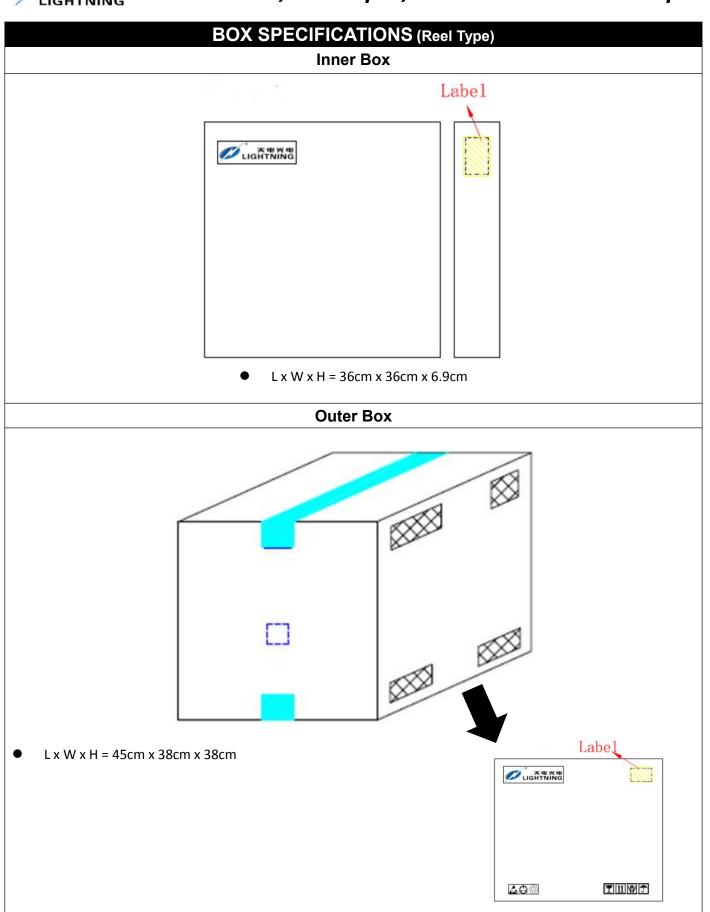


LIGHTNING Carrier Tape Specifications (Dimensions in mm unless otherwise stated) **Option SL(T1)** 4.00 -**-**2.00 ø1,50 -1,75 7,50 16.00 -4.50-12.00 Option SL(T2) -2.004.00 -Ø1.50 -1.757,50 16.00 -4.50-12.00



LIGHTNING REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated) **Option S & Option SL** 100.00 330.00 -ø13.20 16.50 20.50



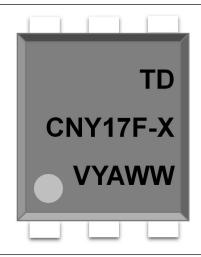


Release Date: 2024/08/19 Document No: DWI-10162 Rev: A00



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

CNY17F-X: Part Number & Rank

: VDE Option V Υ : Fiscal Year

Α : Manufacturing Code

ww : Work Week

ORDERING INFORMATION

CNY17F-X(Y)(Z)-GV

TD - Company Abbr.

CNY17 – Part Number

F – Configuration (F: Without Base,

None: With Base)

-X – Rank (X=1 to 4)

Y – Lead Form Option (M/S/SL/None)

Z – Tape and Reel Option (T1/T2)

G – Material Option (G: Green, None:

Non-Green)

V – VDE Option (V or None)

Bin Code: X No.: XXXXXXXXXX Date Code: XXXX QTY: XXX PCS œ 🏤 🎤 ♣

LABEL INFORMATION

PACKING QUANTITY Option Quantity Quantity - Inner box **Quantity – Outer box** None 65 Units/Tube 32 Tubes/Inner box 10 Inner box/Outer box = 20.8k Units Μ 65 Units/Tube 32 Tubes/Inner box 10 Inner box/Outer box = 20.8k Units S(T1) 1000 Units/Reel 3 Reels/Inner box 5 Inner box/Outer box = 15k Units S(T2) 1000 Units/Reel 3 Reels/Inner box 5 Inner box/Outer box = 15k Units SL(T1) 1000 Units/Reel 3 Reels/Inner box 5 Inner box/Outer box = 15k Units SL(T2) 1000 Units/Reel 3 Reels/Inner box 5 Inner box/Outer box = 15k Units

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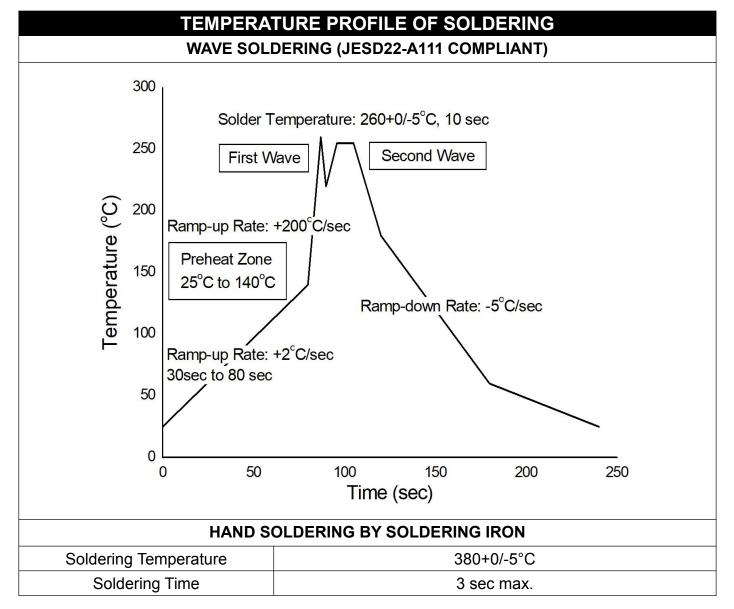
Supplier T_p ≥ T_c Supplier t_p = T_c Supplier t_p = T_c Supplier t_p T_c -5°C Max. Ramp Down Rate = 6°C/s Max. Ramp Down Rate = 6°C/s T_{smin} T_{smin} Preheat Area Time Time Time

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

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IPC-020d-5-1





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



DISCLAIMER

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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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 fitness for particular
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
 over time. All operating parameters, including typical parameters, must be validated in each
 customer application by the customer's technical experts. Product specifications do not expand or
 otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the
 warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.